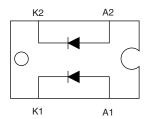
Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 60 A





SOT-227

PRODUCT SUMMARY						
V _R	600 V					
V _F (typical) at 125 °C	1.4 V					
Q _{rr} (typical)	270 nC					
I _{RRM} (typical)	7.0 A					
t _{rr} (typical)	65 ns					
dl _{(rec)M} /dt (typical) at 125 °C	270 A/µs					
I _{F(DC)} at T _C	40 A at 100 °C					

FEATURES

- Fast recovery time characteristic
- Electrically isolated base plate
- Large creepage distance between terminal
- Simplified mechanical designs, rapid assembly
- UL pending
- Totally lead (Pb)-free
- Designed for industrial level

DESCRIPTION

This SOT-227 modules with HEXFRED[®] rectifier are available in two basic configurations. They are the antiparallel and the parallel configurations. The antiparallel configuration (HFA120EA60) is used for simple series rectifier and high voltage application. The parallel configuration (HFA120FA60) is used for simple parallel rectifier and high current application. The semiconductor in the SOT-227 package is isolated from the copper base plate, allowing for common heatsinks and compact assemblies to be built. These modules are intended for general applications such as power supplies, battery chargers, electronic welders, motor control, DC chopper, and inverters.

ABSOLUTE MAXIMUM RATINGS PER LEG					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V _R		600	V	
Continuous forward current		T _C = 25 °C	75		
Continuous forward current	IF	T _C = 100 °C	40	^	
Single pulse forward current	I _{FSM}		TBD	A	
Maximum repetitive forward current	I _{FRM}		180		
RMS isolation voltage, any terminal to case	VISOL	t = 1 minute	2500	V	
Maximum nawar dissinction	P _D	T _C = 25 °C	180	W	
Maximum power dissipation		T _C = 100 °C	71	vv	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to 150	°C	

ELECTRICAL SPECIFICATIONS PER LEG ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		600	-	-	
		I _F = 60 A		-	1.5	1.7	v
Maximum forward voltage V _{FM}	V_{FM}	I _F = 120 A	See fig. 1	-	1.9	2.1	v
		I _F = 60 A, T _J = 125 °C		-	1.4	1.6	
Maximum reverse leakage current		$V_R = V_R$ rated	-		2.5	20	
		T_J = 125 °C, V_R = 0.8 x V_R rated	See fig. 2	-	130	2000	μΑ
Junction capacitance	CT	V _R = 200 V See fig		-	120	170	pF

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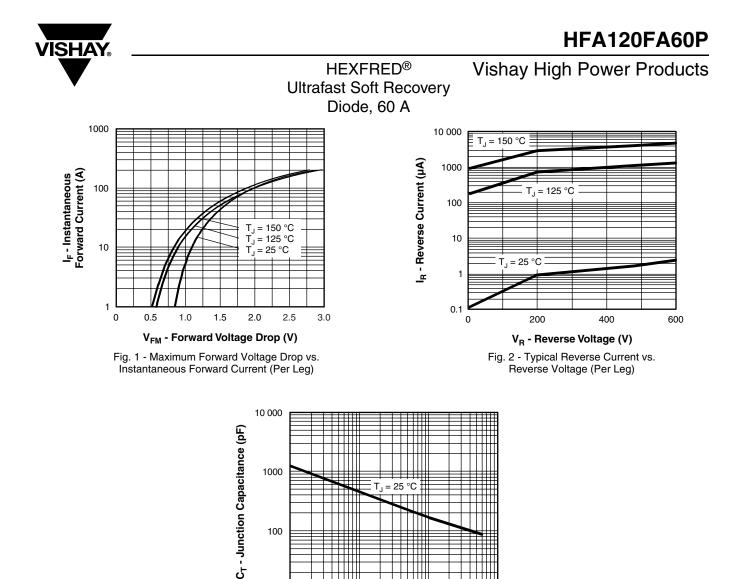
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DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t _{rr}	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	34	-	
Reverse recovery time See fig. 5, 6 and 16	t _{rr1}	T _J = 25 °C		-	65	98	ns
	t _{rr2}	T _J = 125 °C		-	130	200	
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	7.0	13	А
See fig. 7 and 8		l _F = 60 A dl _F /dt = 200 A/μs	-	13	23	A	
Reverse recovery charge	Q _{rr1}	T _J = 25 °C	$V_{\rm R} = 200 \text{ V}$	-	270	410	nC
See fig. 9 and 10	Q _{rr2}	T _J = 125 °C		-	490	740	ne
Peak rate of recovery current during t_b	dl _{(rec)M} /dt1	T _J = 25 °C		-	350	-	A/µs
See fig. 11 and 12	dl _{(rec)M} /dt2	T _J = 125 °C		-	270	-	γγµs

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	
Junction to case, single leg conducting	P	-	-	0.70		
Junction to case, both legs conducting	R _{thJC}	-	-	0.35	°C/W K/W	
Case to sink, flat, greased surface	R _{thCS}	-	0.05	-		
Weight		-	30	-	g	
Mounting torque		-	1.3	-	Nm	

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V_R - Reverse Voltage (V) Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

10

100

10

1

100

1000

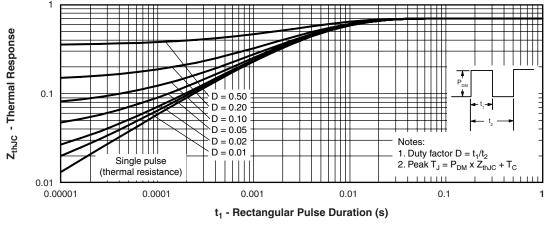


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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VISHAY Vishay High Power Products **HEXFRED[®]** Ultrafast Soft Recovery Diode, 60 A 200 4000 200 V = 200 V = 125 °C = 25 °C 125 °C °C 25 = 120 A 160 3000 60 A = 120 A 30 A = 60 A t_{rr} (ns) Q_{rr} (nC) $I_{F} = 30 \text{ A}$ 120 2000 80 EEEEE 1000 40 0 100 1000 100 1000 dl_F/dt (A/µs) dl_F/dt (A/µs)

Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

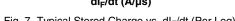


Fig. 7- Typical Stored Charge vs. dl_F/dt (Per Leg)

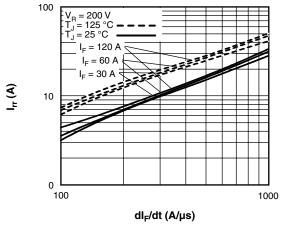


Fig. 6 - Typical Recovery Current vs. dl_F/dt (Per Leg)

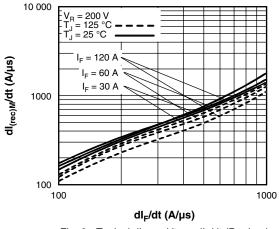


Fig. 8 - Typical dI_{(rec)M}/dt vs. dI_F/dt (Per Leg)



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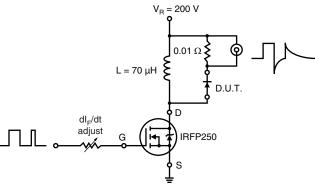
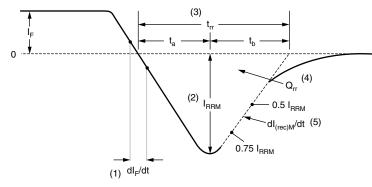


Fig. 9 - Reverse Recovery Parameter Test Circuit



(1) dl_F/dt - rate of change of current through zero crossing

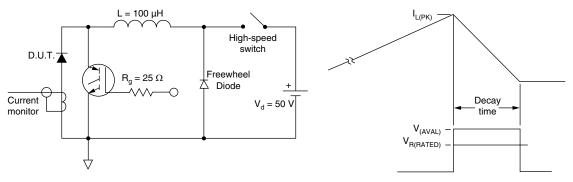
(4) \mathbf{Q}_{rr} - area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

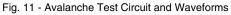
(2) I_{RRM} - peak reverse recovery current

(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current. $Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$ (5) dI_{(rec)M}/dt - peak rate of change of

current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions





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ORDERING INFORMATION TABLE

Device code	HF	Α	120	FA	60	Р	
		2	3	4	5	6	
	 HEXFRED[®] family Process: A electron irradiated 						
	3 - Current rating (120 = 120 A)						
	4 - Package indicator (SOT-227)						
	5 - Voltage rating (60 = 600 V)						
	6 - P = Lead (Pb)-free						

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95036				
Packaging information	http://www.vishay.com/doc?95037			



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